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Honorable Commissioner for Patents
Washington, D.C. 20231

Atty. Docket No.: P67503USO
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Sir:

Transmitted herewith for filing is the patent application in the names of:

Ji Suk HONG of Kyoungki-do, Republic of Korea; and
Chul Chan CHOI of Kyoungki-do, Republic of Korea,

for **METHOD FOR FABRICATING SEMICONDUCTOR MEMORY DEVICE**. The application comprises a 14-page specification including 10 claims (1 independent) and Abstract, 6 sheets of drawings (Figs. 1A-4D), and a Declaration and Power of Attorney.

Accompanying this application for filing are:

- (1) Assignment document, cover sheet and \$40.00 fee for recordation of Assignment;
- (2) Information Disclosure Statement, PTO-1449 form and copies of references; and
- (3) A certified copy of Korean Application No. 2001-52867, filed August 30, 2001, the priority of which is claimed under 35 U.S.C. §119.


The filing fee has been calculated as shown:

Large Entity		\$ 740.00
Total Claims=10;	in excess of 20 = 0 x (\$18.00) =	0.00
Total Ind. Claims=01;	in excess of 03 = 0 x (\$84.00) =	+ 0.00
TOTAL FILING FEE:		\$ 740.00

A check in the amount of \$780.00, is enclosed to cover the total Filing Fee and an Assignment Recordation Fee. The Commissioner is hereby authorized to charge payment of any fees set forth in Sections 1.16 or 1.17 during the pendency of this application, or credit any overpayment, to deposit Account No. 06-1358. A duplicate copy of this sheet is enclosed.

Respectfully submitted,

Enclosures
YSH:ecl

By: 
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